



**P-Channel Enhancement-Mode Vertical DMOS Power FETs**

**Ordering Information**

BV <sub>DSS</sub> / BV <sub>DGS</sub>	R <sub>DS(ON)</sub> (max)	I <sub>D(ON)</sub> (min)	Order Number / Package			
			TO-3	TO-39	TO-220	DICE
-160V	5Ω	-1.5A	VP1116N1	VP1116N2	VP1116N5	VP1116ND
-200V	5Ω	-1.5A	VP1120N1	VP1120N2	VP1120N5	VP1120ND

**Features**

- Freedom from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>ISS</sub> and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-Channel devices

**Advanced DMOS Technology**

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

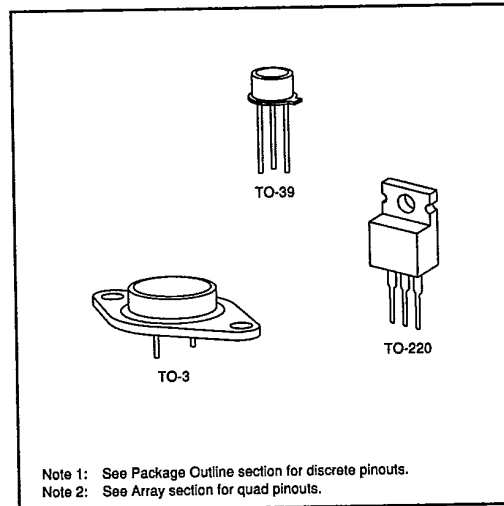
Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

**Applications**

- Motor control
- Convertors
- Amplifiers
- Switches
- Power supply circuits
- Driver (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

**Package Options**

(Notes 1 and 2)



Note 1: See Package Outline section for discrete pinouts.  
 Note 2: See Array section for quad pinouts.

**Absolute Maximum Ratings**

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\*Distance of 1.6 mm from case for 10 seconds.

# Thermal Characteristics

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Package	$I_D$ (continuous)*	$I_D$ (pulsed)*	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{JA}$ °C/W	$\theta_{JC}$ °C/W	$I_{DR}$	$I_{DRM}^*$
TO-3	-2.5A	-7.5A	75W	50	1.6	-2.5A	-7.5A
TO-39	-0.8A	-3A	6W	125	20.8	-0.8A	-3A
TO-220	-1.8A	-7A	45W	70	2.7	-1.8A	-7A

\*  $I_D$  (continuous) is limited by max rated  $T_J$ .

# Electrical Characteristics (@ 25°C unless otherwise specified)

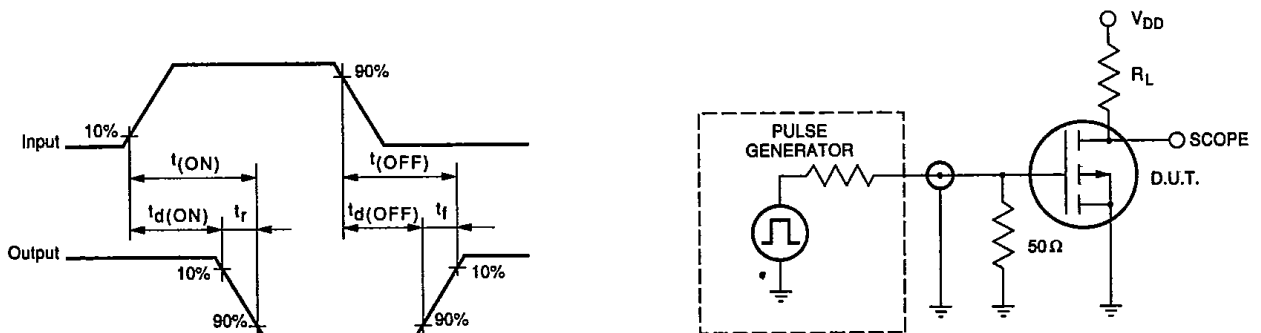
(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	VP1120	-200		V	$I_D = -5\text{mA}, V_{GS} = 0$
		VP1116	-160			
$V_{GS(th)}$	Gate Threshold Voltage	-1.5		-3.5	V	$V_{GS} = V_{DS}, I_D = -5\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-3.5	-6	mV/°C	$I_D = -5\text{mA}, V_{GS} = V_{DS}$
$I_{GSS}$	Gate Body Leakage			-100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
$I_{DSS}$	Zero Gate Voltage Drain Current			-50	$\mu\text{A}$	$V_{GS} = 0, V_{DS} = \text{Max Rating}$
				-10	mA	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current	0.5	1.5		A	$V_{GS} = -5\text{V}, V_{DS} = -25\text{V}$
		1.5	4			$V_{GS} = -10\text{V}, V_{DS} = -25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		3.3	7	$\Omega$	$V_{GS} = -5\text{V}, I_D = -0.5\text{A}$
			3	5		$V_{GS} = -10\text{V}, I_D = -1.0\text{A}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.8	1.2	%/°C	$I_D = -1.0\text{A}, V_{GS} = -10\text{V}$
$G_{FS}$	Forward Transconductance	0.5	0.75		$\text{S}$	$V_{DS} = -25\text{V}, I_D = -1.0\text{A}$
$C_{ISS}$	Input Capacitance		300	350	pF	$V_{GS} = 0, V_{DS} = -25\text{V}$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance		60	80		
$C_{RSS}$	Reverse Transfer Capacitance		10	25		
$t_{d(ON)}$	Turn-ON Delay Time		8	25	ns	$V_{DD} = -25\text{V}$ $I_D = -1.0\text{A}$ $R_S = 50\Omega$
$t_r$	Rise Time		4	20		
$t_{d(OFF)}$	Turn-OFF Delay Time		24	40		
$t_f$	Fall Time		8	20		
$V_{SD}$	Diode Forward Voltage Drop		-1.2	-2.0	V	$I_{SD} = -1.0\text{A}, V_{GS} = 0$
$t_{rr}$	Reverse Recovery Time		350		ns	$I_{SD} = -1.0\text{A}, V_{GS} = 0$

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 $\mu\text{s}$  pulse, 2% duty cycle.)

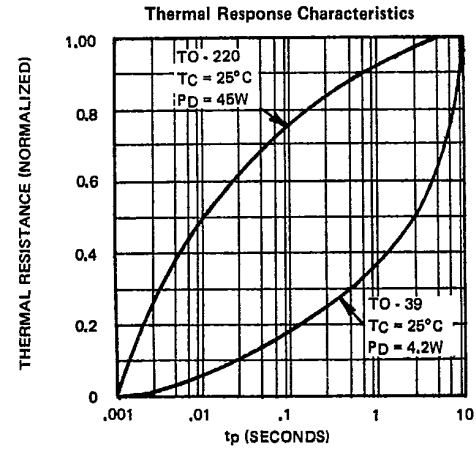
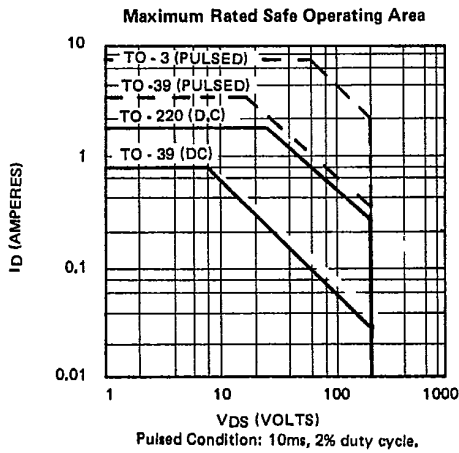
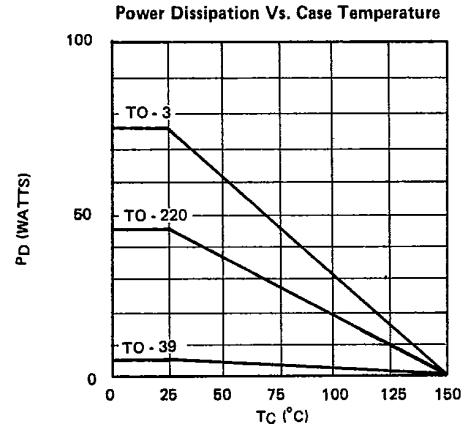
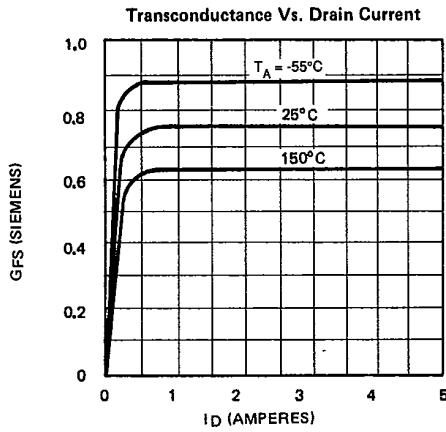
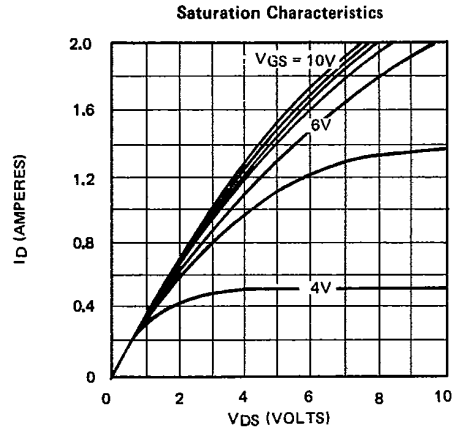
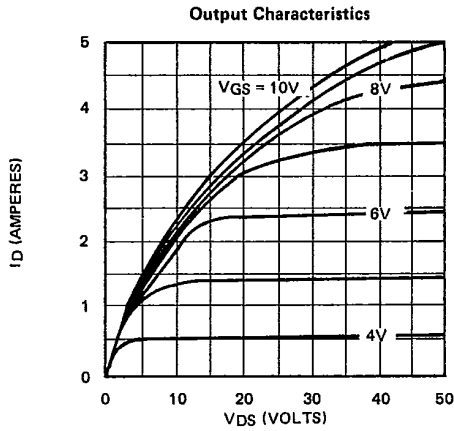
Note 2: All A.C. parameters sample tested.

# Switching Waveforms and Test Circuit



Typical Performance Curves

T.39.19



T-39-19

